

the said on PCB shield zone and the inside of the said metallic shield
expansion housing cover

Heat conduct means on top of the said metallic shield expansion housing
cover

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Abstract:

Page 8, line 8, change "computer system board 10 comprises dual shield" to –
computer system board 10 comprises dual on PCB shield—

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Page 8, line 10, change "113 (123) in the shield" to –113 (123) inside the on PCB
shield—

Page 8, line 11 to 12, change "the shield metal housing cover" to –the metallic
shield housing cover—

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Page 8, line 13, change "by shield expansion zone" to –by the on PCB shield
expansion zone—

Page 8, line 15 to 16, change "the shield metal ...expansion board in side" to –
The metallic shield housing cover 20 and the on PCB expansion zone 11
(12) function as the heat sink for the expansion board inside.—

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Page 8, line 17, change "solutions guarantee the system processing high
reliability" to –solutions ensure the system processing with high reliability--

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